

COPY OF PAPERS ORIGINALLY FILED

ATTORNEY DOCKET NO. 00-SZ-

DECLARATION AND POA 02/10/00

DECLARATION AND POWER OF ATTORNEY FOR NEW PATENT APPLICATION

As a below named inventors, we hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

CURRENT AMPLIFIER STRUCTURE

	the specification of v	vhich:							
	[] is attached heret	0.							
	[X] was filed on 8 I	February 2002 as seria	al no						
	and was ame	nded on							
-									
Į.	I hereby state that I have reviewed and understand the contents of the above-identified								
Pare?	specification including the claims, as amended by any amendment referred to above.								
Maria	I acknowledge the duty to disclose information which is material to the examination of this								
ė z	application in accordance with Title 37, Code of Federal Regulations, §1.56.								
	I hereby claim foreign priority benefits under Title 35, United states Code, §119 of any foreign								
	application(s) for patent or inventor's certificate listed below and have also identified below any foreign								
=	application for patent or inventor's certificate having a Filing date before that the application on which								
dunit.	priority is claimed.								
	Foreign Application(s), if any, for Patent or Inventor's Certificated Filed Within 12 Months Prior to								
ia		the Filing Date of This Application:							
1			Date of Filing	Priority Claimed					
g a	Country	Application No.	(day, month, year)	Under 35 U.S.C.	<u>§119</u>				
=									
	China	01104518.3	10 February 2001	[x] YES [] NO					
				[]YES	[] NO				
			40.70	[]YES	[]NO				
	A 11 T7 A		D	1 410° 4 TOTA 1314	TT 10.3.6 .11				
	All Foreign Applications, if any, for Patent or Inventor's Certificate Filed More Than 12 Month's Prior to the Filing Date of This Application:								
	rnor to the rning Da	ite of This Application	1,						
	Country	Application No.	Date of Filing						
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Page 2

application(s) for application for pa priority is claimed Prior Foreign Ap	atent or inventor's d.	es certificate listed below an certificate having a filing dat	nd have also identified below any foreign e before that of the application on which
Number	Country	Day/Month/Year Filed	Priority Claimed
		<u></u>	YesNo
			YesNo
I hereby of application(s) list		der Title 35, United States (Code, §119 of any United States provisional
	Application Numb	er <u>Filing Date</u>	:
a definition in the state of th			
I hereby application(s) list disclosed in the punited States Coas defined in Title	ted below and, inso prior United States ode §112, I acknow e 37, Code of Fede	ofar as the subject matter of eapplication in the manner probledge the duty to disclose in	ates Code, §120 of any United States each of the claims of this application is not rovided by the first paragraph of Title 35, formation which is material to patentability a became available between the Filing date ling date of this application.
☐ Application		Sta	tus
Serial No.	Date of Filin	g (patented,	pending abandoned
I hereby	appoint the following Patent and Trade	ing attorney(s) and/or agent(mark Office connected there	s) to prosecute this application and transact with:

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign

Lisa K. Jorgenson, Reg. No. 34,845 Robert D. McCutcheon, Reg. No. 38,717 Mario Donato, Reg. No. 37,816 Nainesh P. Shah, Reg. No. 40,166 Renee' Michelle Larson, U.S. Reg. No. 36,193 Send Correspondence and direct telephone calls to:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 of the U. S. Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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